

## Features:

- •Long operating life
- •Low Power Consumption
- •Low voltage DC operated
- RoHS Compliant

## **Application**:

- •Status indicator
- Industrial control panel
- •Sensor status indication
- •Wearable and portable devices



Part Number	Dice Material	Emitted Color	Lens Color
E6Q1206UYAC1UDA	AlGaInP	Yellow	Water Clear

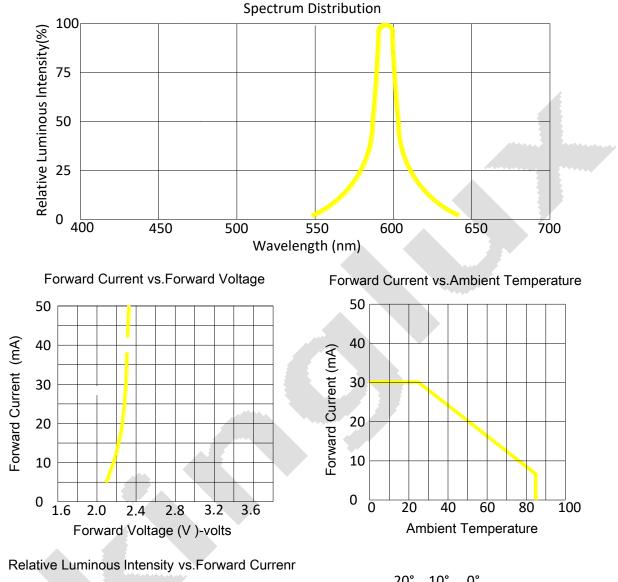
# Electro-Optical Characteristics(Ta=25°C, @20mA)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Luminous Intensity	IV	200	-	600	mcd
Radiation Bandwidth	$ riangle \lambda$	-	35	-	nm
Forward Voltage	VF	1.90	2.00	2.40	v
Luminous Flux	Φ	-	-	-	Lm
Dominant Wavelength	λd	587	590	595	nm
CIE Coordinates CIE	х,у	-	-	-	-
Color Temperature	Тс	-	-	-	k
Viewing Angle	201/2	-	30	-	deg
Reverse Current	IR	_	_	10	uA

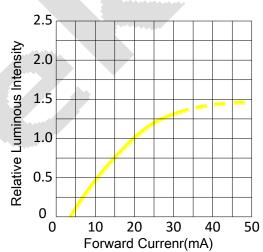
## Absolute Maximum Ratings(Ta=25°C)

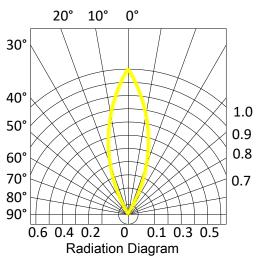
Parameter	Symbol	Max.	Unit
Peak Forward Current(1/10 Duty Cycle, 0.1ms Pulse Width)	IPF	100	mA
Forward Current	IF	30	mA
Reverse Voltage	VR	5	v
Electrostatic Discharge	ESD	2000	V
Operating Temperature Range	Topr	-40to+90	°C
Storage Temperature Range	Tstg	-40to+90	°C
Reflow Soldering	Tsld	260°Cfor 10secs	





## **Optical & Electrical Characteristics**







## **Bin Limits**

### Bin Range Of Luminous Intensity (Unit:mcd)

Bin Code	Min	Max	Condition
L1	200	400	
L2	400	600	IF=20mA
L3	_	-	

#### Bin Range Of Forward Voltage (Unit:V)

Bin Code	Min	Max	Condition
V1	1.9	2.0	
V2	2.0	2.1	
V3	2.1	2.2	IF=20mA
V4	2.2	2.3	
V5	2.3	2.4	

#### Bin Range Of Wavelength (Unit:nm)

Bin Code	Min	Max	Condition
Y1	587	589	
Y2	589	591	
Y3	591	593	IF=20mA
Y4	593	595	
Y5	-	-	

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Forward Voltage ±0.1V



## **Reliability** Test Items And Conditions

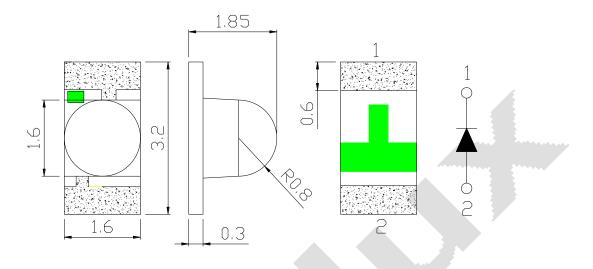
Test Items	Reference	<b>Test Conditions</b>	Time	Quantity	Criterion
Thermal Shock	MIL-STD-202G	-40℃ (30min) -100℃ (30min)	100 Cycles	22	0/22
Temperature And Humidity Cyclic	JEITA ED-4701 200 203	-10℃~65℃; 0%~90%RH	10cycles	22	0/22
High Temperature Storage	JEITA ED -4071 200 201	Ta=100℃	1000H	22	0/22
Low Temperature Storage	JEITA ED -4071 200 202	<b>Та=-40</b> °С	1000H	22	0/22
High Temperature High Humidity Storage	JEITA ED -4071 100 103	Ta=60°C ; RH=90%	1000H	22	0/22
High Temperature Life Test	JESD22-A108D	Ta=80℃	1000H	22	0/22
Life Test	JESD22-A108D	Ta=25℃ IF=20mA	1000H	22	0/22
Resistance to Sodering Heat	GB/T 4937, II, 2.2&2.3	Tsol*=(240±5) ℃10secs	2 times	22	0/22

# **Criteria For Judging Damage**

Test Items	Symbol	Test Conditions	Criteria For Judging Damage	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =I <sub>FT</sub>	Initial Data±10%	
Recerse Current	I <sub>R</sub>	V <sub>R</sub> =5V	I <sub>R</sub> ≤10uA	
Luminous Intensity	IV	I <sub>F</sub> =I <sub>FT</sub>	Average I <sub>V</sub> degradation≤30%; Single LED I <sub>V</sub> degradation≤50%	
Resistance to Soldering Heat	-	-	Meterial without internal cracks,no meterial between stripped,no deaded light	
Soldering Heat between stripped, no deaded light				



## **Product size (Unit:mm)**



NOTES :

1. All dimensions are in millimeters (inches)

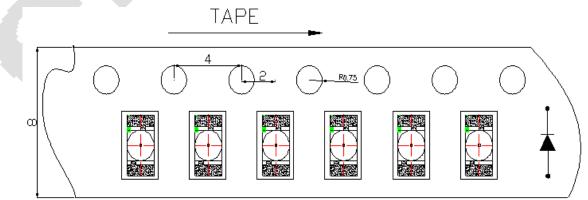
2. Tolerances are  $\pm 0.2 \text{mm}$  (0.008inch) unless otherwise noted

# Recommended Soldering Pad Design (Unit:mm)



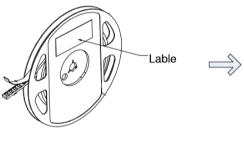
## Taping and package Spec

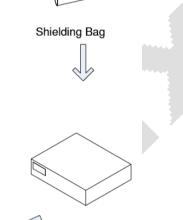
• Tape Specification: 3,000 pcs Per Reel

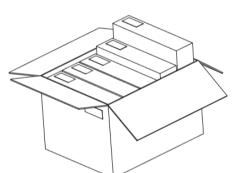




## Packaging







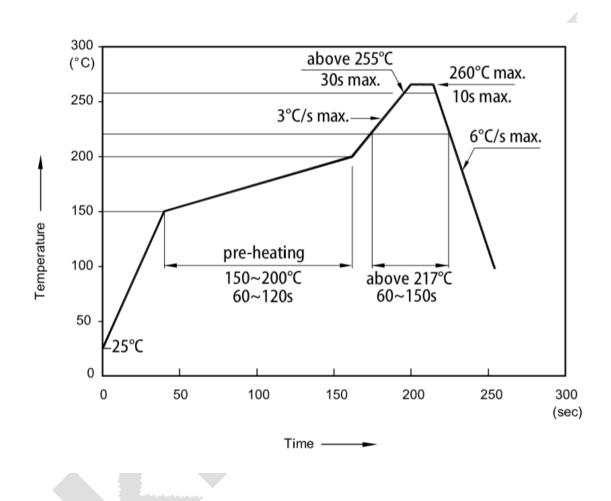
# LabelStyle





## **Useful hint**

### **Reflow Soldering Instructions**



- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
- 2. The maximum number of reflow soldering passes is 2 times.
- 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.



### Precautions

### 1. Storage:

•Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.

•Before opening the package, the product should be kept at  $30^{\circ}$ C or less and humidity less than 60% RH, and beused within a year.

•After opening the package, the product should be stored at  $30^{\circ}$ C or less and humidity less than 10%RH, and besoldered within 24 hours (1day). It is recommended that the product be operated at the workshop condition of  $30^{\circ}$ C or less and humidity less than 60%RH.

•If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition:  $(70\pm5)^{\circ}$ C for 24 hours.

#### 2. Static Electricity:

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

#### 3. Vulcanization:

LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline ,seriously affecting the performance of the product.So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.